

DF005M - DF10M

Features

- Surge overload rating: 50 amperes peak.
- Glass passivated junction.
- Low leakage.
- UL certified, UL #E111753.



DIP

Bridge Rectifiers

Absolute Maximum Ratings*

T_A = 25°C unless otherwise noted

Symbol	Parameter	Value						Units	
		005M	01M	02M	04M	06M	M80	10M	
V_{RRM}	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
V _{RMS}	Maximum RMS Bridge Input Voltage	35	70	140	280	420	560	700	V
V _R	DC Reverse Voltage (Rated V _R)	50	100	200	400	600	800	1000	V
I _{F(AV)}	Average Rectified Forward Current, @ $T_A = 40$ °C 1.5			Α					
I _{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	50		Α					
T _{stg}	Storage Temperature Range -55 to +150			°C					
T _J	Operating Junction Temperature	ure -55 to +150		°C					

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P_{D}	Power Dissipation	3.1	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient,* per leg	40	°C/W

^{*}Device mounted on PCB with 0.5×0.5 " (13 x 13 mm).

Electrical Characteristics $T_A = 25^{\circ}C$

T_A = 25°C unless otherwise noted

Symbol	Parameter	Device	Units
V _F	Forward Voltage, per bridge @ 1.0 A	1.1	V
I _R	Reverse Current, total bridge @ rated V_R $T_A = 25^{\circ}C$ $T_{\Delta} = 125^{\circ}C$	5.0 500	μA μA
	I ² t rating for fusing t < 8.35 ms	10	A ² s
Ст	Total Capacitance, per leg V _R = 4.0 V, f = 1.0 MHz	25	pF

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Bridge Rectifiers

(continued)

Typical Characteristics

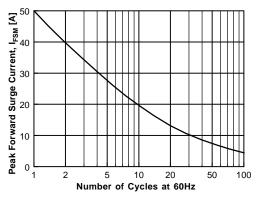


Figure 1. Non-Repetitive Surge Current

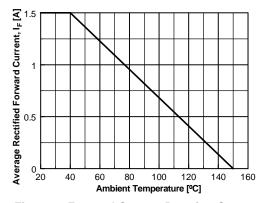


Figure 2. Forward Current Derating Curve

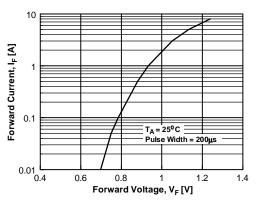


Figure 3. Forward Voltage Characteristics

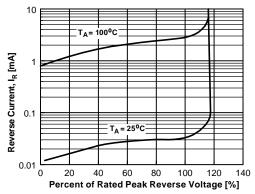


Figure 4. Reverse Current vs Reverse Voltage

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Rev. H4